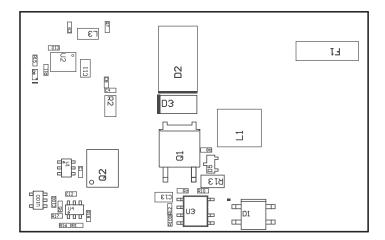


COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE	BOARD #: PMP11295	REV: D	SVN REV	: Not In VersionControl		
	TID #:					
PLOT NAME = Top Assembly Drawing	GENERATED : 10/28/	2015 8:19:31	AM	TEXAS INSTRUMENTS		



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM BOTTOM SIDE	BOARD #: PMP11295	REV: D	SVN REV:	: Not In VersionControl		
	TID #:					
PLOT NAME = Bottom Assembly Drawing	GENERATED : 10/28/	2015 8:19:32	AM	TEXAS INSTRUMENTS		

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